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NXP Semiconductors/Freescale Semiconductor, Inc. 74LVC3G04DC-Q100H

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74LVC3G04-Q100Triple inverter

Rev. 1 — 14 May 2013

Product data sheet

General description

The 74LVC3G04-Q100 provides three inverting buffers.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant outputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-7 (1.65 V to 1.95 V)
 - ◆ JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- \pm 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Multiple package options





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3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | |
|------------------|-------------------|--------|---|----------|--|--|
| | Temperature range | Name | Description | Version | | |
| 74LVC3G04DP-Q100 | –40 °C to +125 °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm | SOT505-2 | | |
| 74LVC3G04DC-Q100 | –40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 | | |

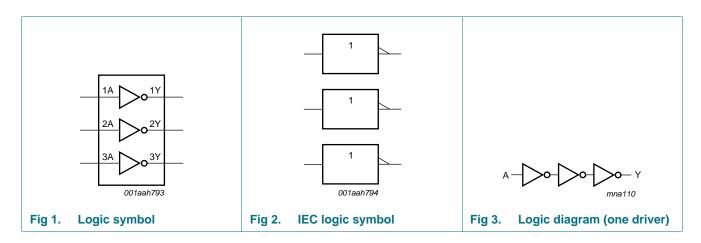
4. Marking

Table 2. Marking codes

| Type number | Marking code ^[1] |
|------------------|-----------------------------|
| 74LVC3G04DP-Q100 | V04 |
| 74LVC3G04DC-Q100 | V04 |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



Product data sheet

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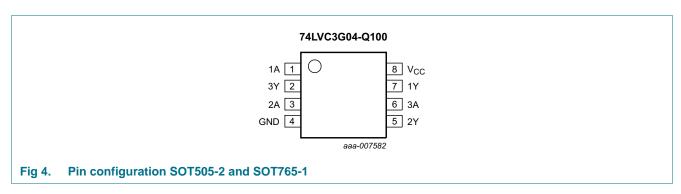


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6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
|-----------------|---------|----------------|
| 1A, 2A, 3A | 1, 3, 6 | data input |
| GND | 4 | ground (0 V) |
| 1Y, 2Y, 3Y | 7, 5, 2 | data output |
| V _{CC} | 8 | supply voltage |

7. Functional description

Table 4. Function table 11

| Input nA | Output nY |
|----------|-----------|
| L | Н |
| Н | L |

[1] H = HIGH voltage level; L = LOW voltage level.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| | | 0 7 (| • | 1.0 | , |
|------------------|-------------------------|--|--------------------|----------------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0 V$ | - | ±50 | mA |
| Vo | output voltage | Active mode | <u>[1]</u> –0.5 | $V_{CC} + 0.5$ | V |
| | | Power-down mode | <u>[1][2]</u> –0.5 | +6.5 | V |
| I _O | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | <u>[3]</u> _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| | | | | | |

^[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------------------|---|------|----------|------|
| V_{CC} | supply voltage | | 1.65 | 5.5 | V |
| VI | input voltage | | 0 | 5.5 | V |
| Vo | output voltage | Active mode | 0 | V_{CC} | V |
| | | Power-down mode; V _{CC} = 0 V | 0 | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | $V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$ | - | 20 | ns/V |
| | | $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$ | - | 10 | ns/V |

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^[2] When $V_{CC} = 0 \text{ V}$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

^[3] For TSSOP8 package: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K. For VSSOP8 package: above 110 °C the value of P_{tot} derates linearly with 8 mW/K.

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10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|----------------------|---------------------------|---|-----------------------|--------|----------------------|------|
| T _{amb} = - | 40 °C to +85 °C | | | | | |
| V_{IH} | HIGH-level input voltage | V _{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7 | - | - | V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | $0.7 \times V_{CC}$ | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | - | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3 \times V_{CC}$ | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -100 \mu A$; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | V _{CC} - 0.1 | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.3 | - | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 100 \mu A$; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | - | 0.10 | V |
| | | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.30 | V |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.40 | V |
| | | $I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | V |
| | | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | V |
| l _l | input leakage current | $V_I = 5.5 \text{ V or GND}$; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$ | - | ±0.1 | ±5 | μΑ |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$ | - | ±0.1 | ±10 | μΑ |
| I _{CC} | supply current | $V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$ | - | 0.1 | 10 | μΑ |
| ΔI_{CC} | additional supply current | per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$ | - | 5 | 500 | μΑ |
| Cı | input capacitance | V_{CC} = 3.3 V; V_I = GND to V_{CC} | - | 2.5 | - | pF |

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Triple inverter

Table 7. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|----------------------|---------------------------|---|----------------------|--------|----------------------|------|
| T _{amb} = - | 40 °C to +125 °C | | | | | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | $0.65 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7 | - | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | $0.7 \times V_{CC}$ | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3 \times V_{CC}$ | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -100 \mu A$; $V_{CC} = 1.65 \text{ V}$ to 5.5 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 0.95 | - | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.7 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.0 | - | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.4 | - | - | V |
| V _{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 100 \mu A$; $V_{CC} = 1.65 \text{ V}$ to 5.5 V | - | - | 0.10 | V |
| | | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.70 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.60 | V |
| | | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.80 | V |
| | | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.80 | V |
| l _l | input leakage current | $V_I = 5.5 \text{ V or GND}$; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$ | - | - | ±20 | μΑ |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}$; $V_{I} \text{ or } V_{O} = 5.5 \text{ V}$ | - | - | ±20 | μΑ |
| Icc | supply current | $V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to 5.5 V}; I_O = 0 \text{ A}$ | - | - | 40 | μΑ |
| Δl _{CC} | additional supply current | per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_1 = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}$ | - | - | 5000 | μΑ |

^[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.



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11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6.

| Symbol | Parameter | Conditions | | -40 °C to +85 °C | | | –40 °C to | o +125 °C | Unit |
|------------------------|-------------------------------|--|-----|------------------|--------|-----|-----------|-----------|------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| t _{pd} propag | propagation delay | nA to nY; see Figure 5 | [2] | | | | | | |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.0 | 3.5 | 8.0 | 1.0 | 9.5 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 0.5 | 2.2 | 4.4 | 0.5 | 5.4 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 0.5 | 2.7 | 5.2 | 0.5 | 7.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 0.5 | 2.7 | 4.1 | 0.5 | 5.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 0.5 | 1.9 | 3.2 | 0.5 | 3.8 | ns |
| C _{PD} | power dissipation capacitance | $V_I = GND \text{ to } V_{CC}; V_{CC} = 3.3 \text{ V}$ | [3] | - | 13.5 | - | - | - | pF |

- [1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.8$ V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

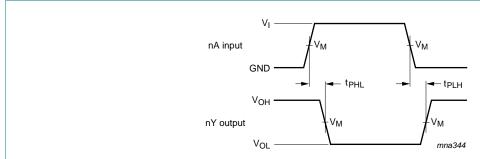
 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

12. Waveforms



Measurement points are given in Table 9.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 5. The input (nA) to output (nY) propagation delays

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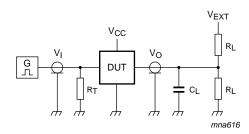


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Table 9. Measurement points

| Supply voltage | Input | Output |
|------------------|---------------------|-----------------------|
| V _{CC} | V _M | V _M |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.3 V to 2.7 V | $0.5 \times V_{CC}$ | 0.5 × V _{CC} |
| 2.7 V | 1.5 V | 1.5 V |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V |
| 4.5 V to 5.5 V | $0.5 \times V_{CC}$ | 0.5 × V _{CC} |



Test data is given in Table 10.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 6. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Input | | Load | V _{EXT} | |
|------------------|----------------|---------------|----------------|------------------|-------------------------------------|
| V _{CC} | V _I | $t_r = t_f$ | C _L | R _L | t _{PLH} , t _{PHL} |
| 1.65 V to 1.95 V | V_{CC} | \leq 2.0 ns | 30 pF | 1 kΩ | open |
| 2.3 V to 2.7 V | V_{CC} | \leq 2.0 ns | 30 pF | 500 Ω | open |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 4.5 V to 5.5 V | V_{CC} | ≤ 2.5 ns | 50 pF | 500 Ω | open |



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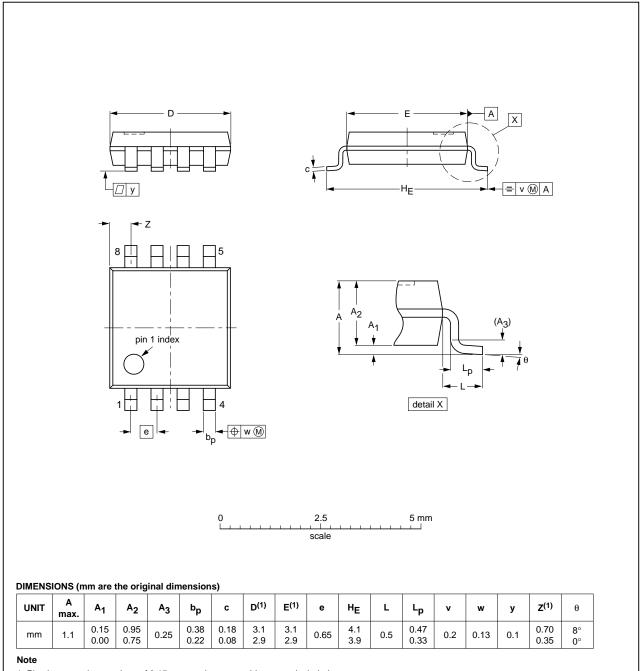
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13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2



1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE | REFERENCES | | | EUROPEAN | ISSUE DATE | | |
|----------|------------|--|-------|----------|------------|------------|--|
| VERSION | IEC JEDEC | | JEITA | | PROJECTION | ISSUE DATE | |
| SOT505-2 | | | | | | 02-01-16 | |

Package outline SOT505-2 (TSSOP8) Fig 7.

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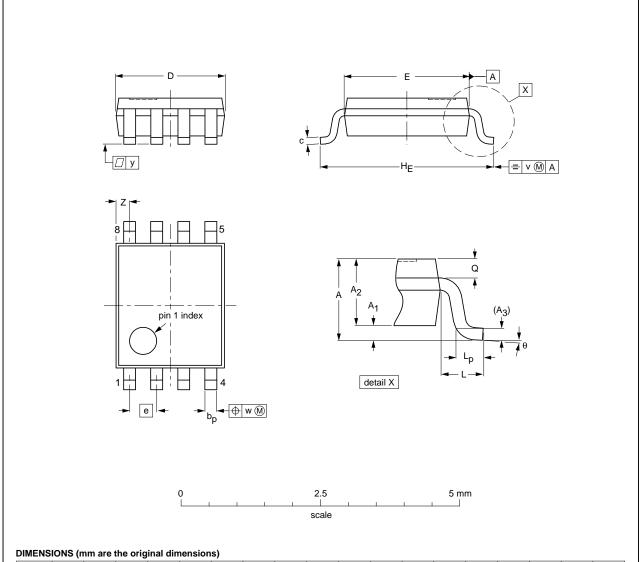


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VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽²⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|-----|------------|-----|--------------|--------------|-----|------|-----|------------------|----------|
| mm | 1 | 0.15 0.00 | 0.85 0.60 | 0.12 | 0.27 0.17 | 0.23 0.08 | 2.1 1.9 | 2.4 2.2 | 0.5 | 3.2 3.0 | 0.4 | 0.40 0.15 | 0.21 0.19 | 0.2 | 0.13 | 0.1 | 0.4 0.1 | 8° 0° |

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----|--------|----------|------------|------------|------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| SOT765-1 | | MO-187 | | | | 02-06-07 | |

Package outline SOT765-1 (VSSOP8) Fig 8.

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14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MIL | Military |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------|--------------|--------------------|---------------|------------|
| 74LVC3G04_Q100 v.1 | 20130514 | Product data sheet | - | - |

74LVC3G04_Q100



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16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Triple inverter

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Triple inverter

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